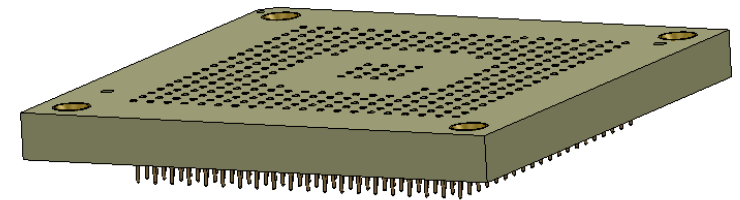
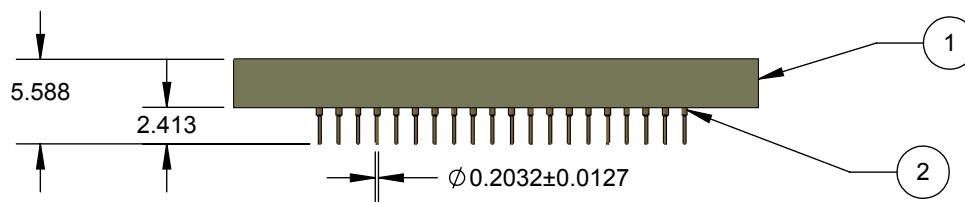


TOP VIEW

ITEM NO.	DESCRIPTION	Material
1	Substrate	3.18mm ±0.125mm [0.125" ±0.005"] FR4/G10 or equivalent high temp material. Non-clad.
2	Pin	Brass - PS-2 Plating: 10u" Au over 50u" Ni min.
3	#0-80 internal Thread brass insert, Press fit	Brass



ISO View




FRONT VIEW

Description: BGA324B land socket, 27mm package, 1.27mm pitch, 20x20 array. Mates with Ironwood GHZ socket

Primary dimension units are millimeters. Secondary dimension units are [inches]. Weight is in grams.

Tolerances: Hole diameters ±0.03mm [±0.001"]. Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise.
Materials and specifications are subject to change without notice.



 <p>LS-BGA324B-05 Drawing Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodelectronics.com</p>	<p>Material: N/A Finish: N/A Weight: 6.34</p>	STATUS: Released	SHEET: 1 OF 1	REV. A
		ENG: E. Smolentseva	SCALE: 2:1	
		FILE: LS-BGA324B-05 Dwg	DATE: 03/04/2013	